

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

pplicant(s)

Neil McLellan et al.

Appl. No.

10/062,650

Group Art Unit:

2825

**Filed** 

January 31, 2002

Examiner

Luu, Chuong A.

For

Improved Integrated Circuit Package And Method of

Manufacturing The Integrated Circuit Package

CAL

IT is ALLEPTABLE TO ENTER

## SUBMISSION OF CORRECTED FORMAL DRAWINGS

Mail Stop Non-Fee Amendment COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicants submit herewith nine (9) sheets of formal drawings, containing drawing figures nos. 1, 2, 3, 4A-4H, 5A-5I, and 6.

Although no fee is believed due in connection with this Submission of Corrected Formal Drawings, the Commissioner is hereby authorized to charge any additional fees which may be required by this paper, or credit any overpayment to Deposit Account No. 13-3250, Order No. 36080-01101. A DUPLICATE COPY OF THIS DOCUMENT IS ATTACHED.

> Respectfully submitted, Milbank, Tweed, Hadley & McCloy LLP

August 14, 2003

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